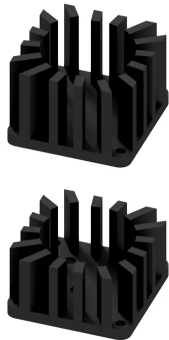


Data sheet Product FK 254 1 SA 3



Board Level heatsinks>Finger shaped heatsinks
for semiconductor-design TO 3

Features

material:	aluminium, EN AW 1050 A, cold extruded part
width:	46 mm
height:	25.4 mm
length:	46 mm
thermal resistance:	5.4 K/W
surface:	black anodised

Technical Drawing

